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1. Name of conveying party(ies): CHEOL KYUN KIM KI HO BAIK Additional name(s) of conveying party(ies) attached? yesX_ no 3. Nature of Conveyance:X_ Assignment Security Agreement Merger Change of Name Other Cotober 20, 1999	2. Name and address of receiving party(ies): Name: Hyundai Electronics Industries Co., Ltd. Internal Address: San 136-1, Ami-ri, Bubal-eub, Ich'on, State Kyoungki-do Country Republic of Korea Additional name(s) & address(es) attached? Yes X No	
A. Patent Application No.(s) Additional numbers attached? Yes X No		
Name and address of party to whom correspondence concerning document should be mailed: Name:John K. Kim	 6. Total number of applications and patents involved:	
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JOHN K. KIM Name of Person Signing Reg. No. 37,002	on is true and correct and any attached copy is a true copy of the $\frac{i / f e / c c}{\text{Date}}$ Total number of pages comprising cover sheet: $\underline{2}$	

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PATENT REEL: 010419 FRAME: 0732

ASSIGNMENT

		ASSIGNMENT	
Full Name(s) and Post Office Address(es) of Inventor(s) (including Country)	WHEREAS, Cheol Kyun, Kim	603-786 Donasuna Touar Shiringa-dona	
	1. Chungnang-gu, Seoul,	, residing at 603-786, Dongsung Tower, Shirinae-dong,	
		residing at 203-402, Daewoo Apt., Jeungpo-dong,	
	Ich'on, Kyoungki-do,	Korea	
		, residing at	
	<u> </u>	, reading at	
	4.	, residing at	
	5.	, residing at	
		; and	
	6.	, residing at	
Title of Invention	(hereinafter referred to as ASSIGNOR(S STENCIL MASK	has/have invented and own(s) a new and original invention entitled	
	X for which an application for United States Letters Patent has been executed by ASSIGNOR(S) concurrently herewith.		
Cneck One	for which an application for United States Letters Patent was filed on		
	as Application Serial No.		
Full Name,	WHEREAS, Hyundai Electr	onics Industries Co., Ltd.	
Legal entity,	a	organized and existing under the laws of Republic of Korea and	
Country, and Address of Assignee	having a place of business at San 136-1, Ami-ri, Bubal-eub, Ich'on, Kyoungki-do, Korea		
	(hereinafter referred to as ASSIGNEE) is desirous of acquiring all right, title and interest in and to said invention, said application and any Letters Patent that may be granted thereon or therefrom.		
	which is hereby acknowledged, ASSIGN interest in and for the United States of Al continuation, continuation-in-part, substit America, and the Commissioner of Paten and/or applications resulting therefrom to him/them and his/their legal representate execute and deliver all divisional, continusaid invention and all assignments the representatives all facts known to the unowhich any of said applications or patents everything necessary to aid said ASSIGN	eration of One U.S. Dollar (US\$1.00) and other good and valuable consideration, the receipt of DR(S) hereby sell(s), assign(s) and set(s) over to said ASSIGNEE the entire right, title and herica in and to said invention and the aforesaid application for patent, all original, divisional, atteing or reissue applications and patents applied for origranted therefor in the United States of and Trademarks is hereby authorized and requested to issue all patents on said application said ASSIGNEE herein, as assignee of the entire interest therein; and the undersigned for ves, heirs and assigns do(es) hereby agree and covenant, without further remuneration, to ation, continuation-in-part, reissue and other applications for United States Letters Patent on eof to said ASSIGNEE or its assigns, to communicate to said ASSIGNEE or its legal ersigned respecting said invention, to testify in any interferences or other legal proceedings in may become involved, to sign all lawful papers, make all rightful oaths and to do generally EE, its successors, assigns and nominees in obtaining patent protection on said invention in as incident to said applications to be borne and paid by said ASSIGNEE.	
Signature(s) of of Inventor(s)	IN WITNESS WHEREOF, the ASSIGNOR(S) has/have hereunto set hand and seal this on the date(s) opposite his/their signature(s).		
	Date: OLtober 20, 1999 Inventor	Witness: J. Y. Kim T Name: Cheol Kyun, Kim Ji Young, Kim	
	Date: 10/20/ /999 Invento	Witness: J. V. Kim T. Mame: Ki Ho, Baik Ji Young, Kim	
	Date:	Witness:	
	Invento	r Name:	
	Date:	Witness:	
	invento	r Name:	

This Assignment should preferably be singed before a Notary Public if executed in the United States, or before a United States Consul if executed abroad. If not, the execution of this Assignment by each inventor should be witnessed by at least one witness.

Inventor Name:

Inventor Name:

PATENT REEL: 010419 FRAME: 0733

Witness:

RECORDED: 11/18/1999